EPO-TEK® H20E-LC

Epoxy; Epoxide

Epoxy Technology Inc.

Message:

EPO-TEK® H20E-LC is a two component, silver-filled epoxy system designed specifically for chip bonding in microelectronic and optoelectronic applications. It is also used extensively for thermal management applications due to its high thermal conductivity. It has proven itself to be extremely reliable over many years of service and is the conductive adhesive of choice for low chloride applications.

General Information			
Filler / Reinforcement	Silver		
Features	Electrically Conductive		
	Fast Cure		
	Thermally Conductive		
Uses	Adhesives		
	Bonding		
	Electrical/Electronic Applications		
	LCD Applications		
	LEDs		
Agency Ratings	EC 1907/2006 (REACH)		
	EU 2003/11/EC		
	EU 2006/122/EC		
RoHS Compliance	RoHS Compliant		
Forms	Paste		
Physical	Nominal Value	Unit	
lon Type			
CI-	11	ppm	
К+	2	ppm	
Na+	6	ppm	
NH4+	259	ppm	
Particle Size	< 45.0	μm	
Degradation Temperature	451	℃	
Die Shear Strength - >5 kg (23°C)	11.7	MPa	
Operating Temperature			
Continuous	-55 to 200	°C	
Intermittent	-55 to 300	°C	
Storage Modulus	6.48	GPa	
Thixotropic Index	4.60		
Weight Loss on Heating			

200°C	0.42	%
250°C	1.0	%
300°C	2.0	%
Thermal	Nominal Value	Unit
Glass Transition Temperature ¹	> 80.0	°C
CLTE - Flow		
2	4.4E-5	cm/cm/°C
3	1.7E-4	cm/cm/°C
Thermal Conductivity	2.0	W/m/K
Thermoset	Nominal Value	Unit
Thermoset Components		
Part A	Mix Ratio by Weight: 1.0	
Part B	Mix Ratio by Weight: 1.0	
Shelf Life (23°C)	52	wk
Uncured Properties	Nominal Value	Unit
Color		
4	Silver	
5	Silver	
Density		
Part A	2.41	g/cm ³
Part B	3.06	g/cm ³
Viscosity ⁶ (23°C)	2.2 to 3.2	Pa·s
Curing Time (150°C)	1.0	hr
Pot Life	5800	min
Cured Properties	Nominal Value	Unit
Shore Hardness (Shore D)	60	
Lap Shear Strength (23°C)	11.5	MPa
Volume Resistivity (23°C)	< 4.0E-4	ohms·cm
NOTE		
1.	Dynamic Cure 20-200°C/ISO 25 Min; Ramp -10-200°C @ 20°C/Min	
2.	Below Tg	
3.	Above Tg	
4.	Part B	
5.	Part A	
6.	100 rpm	
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